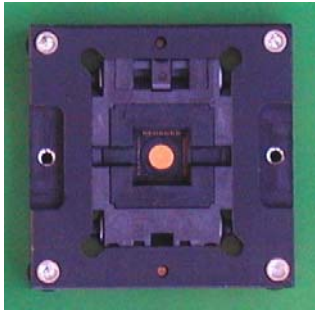




Plastronics and RTI announce failure analysis sockets for QFN, MLP, and other packages



Plastronics and Robson Technologies, Inc. (RTI) have entered into a technology partnership and distributor agreement to manufacture and sell failure analysis QFN sockets. RTI has developed a low profile open top FA socket based upon Plastronics' large selection of QFN burn-in sockets. In addition, RTI has developed compatible FA evaluation boards, ESD boards, engineering evaluation, and other DUT boards for the Plastronics and RTI/Plastronics QFN sockets.

The RTI/Plastronics FA sockets incorporate a screw-down very low-profile open-top lid to enable micro probing, liquid crystal analysis and other FA and engineering applications. The lids are available in anodized aluminum and plastic. The sockets incorporate a short electrical path for low inductance and capacitance and a modular design to maintain a small outline and footprint.

Plastronics offers the largest selection of QFN sockets available in the industry today. With burn-in sockets for MLF, MLP, LPCC and BCC packages ranging in body sizes from 3 x 3 mm to 12 x 12 mm, Plastronics has designed and/or tooled more than 200 configurations to date. Plastronics offers sockets with pitches of 0.4 mm, 0.5 mm, 0.65 mm and 0.8 mm for packages with lead counts from 4 to 100 leads. RTI will stock the more popular sizes of the Plastronics sockets in addition to stocking many of the RTI/Plastronics FA sockets and related DUT boards.

Most of the Plastronics sockets, RTI/Plastronics FA sockets and RTI related boards are available within one week. If stock is not available, delivery can be made within four weeks.

About Plastronics:

Plastronics was founded over 30 years ago for the exclusive purpose of designing, manufacturing and marketing high-quality burn-in sockets. Through advanced product design, state-of-the-art molding and automated production, Plastronics continues to break the barrier for innovative, cost-effective solutions. Plastronics has the largest "tooled" burn-in socket lines for BGA and QFN packages manufactured in the United States today. For additional information, visit Plastronics' web site at www.PlastronicsUSA.com.

About RTI:

RTI was founded 15 years ago to provide test interface solutions for semiconductor and hybrid packages. Products include test sockets, DUT boards for test equipment, FA fixtures, switch and breakout boxes, black box interfaces, probe card blanks, high speed cables, and many other types of PCB and mechanical test fixtures. RTI has in-house PCB and 3D mechanical design and a CNC machine shop for engineering and production. For additional information, visit RTI's web site at www.testfixtures.com or contact Bill Robson at 408-779-8008